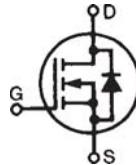


**HiPerRF™**  
**Power MOSFETs**  
**F-Class: MegaHertz Switching**

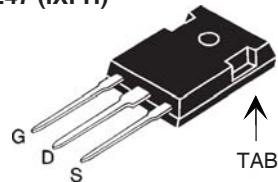
N-Channel Enhancement Mode  
Avalanche Rated, Low  $Q_g$ , Low  
Intrinsic  $R_g$ , High  $dV/dt$ , Low  $t_{rr}$

**IXFH21N50F**  
**IXFT21N50F**

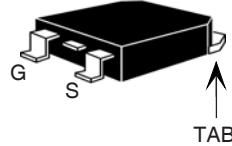
$V_{DSS}$  = 500V  
 $I_{D25}$  = 21A  
 $R_{DS(on)}$  ≤ 250mΩ  
 $t_{rr}$  ≤ 250ns



TO-247 (IXFH)



TO-268 (IXFT)



G = Gate      D = Drain  
S = Source      TAB = Drain

Symbol	Test Conditions	Maximum Ratings	
$V_{DSS}$	$T_J = 25^\circ\text{C}$ to $150^\circ\text{C}$	500	V
$V_{DGR}$	$T_J = 25^\circ\text{C}$ to $150^\circ\text{C}$ , $R_{GS} = 1\text{M}\Omega$	500	V
$V_{GSS}$	Continuous	± 20	V
$V_{GSM}$	Transient	± 30	V
$I_{D25}$	$T_C = 25^\circ\text{C}$	21	A
$I_{DM}$	$T_C = 25^\circ\text{C}$ , Pulse Width Limited by $T_{JM}$	84	A
$I_{AR}$	$T_C = 25^\circ\text{C}$	21	A
$E_{AS}$	$T_C = 25^\circ\text{C}$	1.5	J
$dV/dt$	$I_S \leq I_{DM}$ , $di/dt \leq 100\text{A}/\mu\text{s}$ , $V_{DD} \leq V_{DSS}$ $T_J \leq 150^\circ\text{C}$ , $R_G = 2\Omega$	10	V/ns
$P_D$	$T_C = 25^\circ\text{C}$	300	W
$T_J$		-55 ... +150	°C
$T_{JM}$		150	°C
$T_{stg}$		-55 ... +150	°C
$T_L$	Maximum Lead Temperature for Soldering	300	°C
$T_{SOLD}$	Plastic Body for 10s	260	°C
$M_d$	Mounting Torque (TO-247)	1.13/10	Nm/lb.in.
<b>Weight</b>	TO-247 TO-268	6 4	g g

Symbol	Test Conditions ( $T_J = 25^\circ\text{C}$ , Unless Otherwise Specified)	Characteristic Values		
		Min.	Typ.	Max.
$BV_{DSS}$	$V_{GS} = 0\text{V}$ , $I_D = 1\text{mA}$	500		V
$V_{GS(th)}$	$V_{DS} = V_{GS}$ , $I_D = 4\text{mA}$	3.0		V
$I_{GSS}$	$V_{GS} = \pm 20\text{V}$ , $V_{DS} = 0\text{V}$			± 100 nA
$I_{DSS}$	$V_{DS} = V_{DSS}$ $V_{GS} = 0\text{V}$			50 μA 1.5 mA
$R_{DS(on)}$	$V_{GS} = 10\text{V}$ , $I_D = 0.5 \cdot I_{D25}$ , Note 1			250 mΩ

### Features

- RF capable MOSFETs
- Double metal process for low gate resistance
- Rugged polysilicon gate cell structure
- Unclamped Inductive Switching (UIS) rated
- Low package inductance
- Fast intrinsic rectifier

### Applications

- DC-DC converters
- Switched-mode and resonant-mode power supplies, >500kHz switching
- DC choppers
- 13.5 MHz industrial applications
- Pulse generation
- Laser drivers
- RF amplifiers

### Advantages

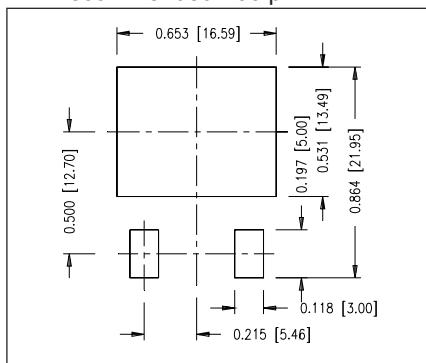
- Space savings
- High power density

Symbol	Test Conditions ( $T_J = 25^\circ\text{C}$ Unless Otherwise Specified)	Characteristic Values		
		Min.	Typ.	Max.
$g_{fs}$	$V_{DS} = 10\text{V}$ , $I_D = 0.5 \cdot I_{D25}$ , Note 1	12	17	S
$C_{iss}$		2600		pF
$C_{oss}$	$V_{GS} = 0\text{V}$ , $V_{DS} = 25\text{V}$ , $f = 1\text{MHz}$	470		pF
$C_{rss}$		160		pF
$t_{d(on)}$		16		ns
$t_r$		12		ns
$t_{d(off)}$		36		ns
$t_f$	$R_G = 2\Omega$ (External)	7.7		ns
$Q_{g(on)}$		77		nC
$Q_{gs}$	$V_{GS} = 10\text{V}$ , $V_{DS} = 0.5 \cdot V_{DSS}$ , $I_D = 0.5 \cdot I_{D25}$	21		nC
$Q_{gd}$		40		nC
$R_{thJC}$			0.42	$^\circ\text{C}/\text{W}$
$R_{thCS}$	(TO-247)	0.21		$^\circ\text{C}/\text{W}$

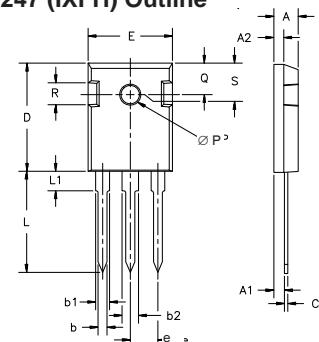
Source-Drain Diode $T_J = 25^\circ\text{C}$ Unless Otherwise Specified)		Characteristic Values		
		Min.	Typ.	Max.
$I_s$	$V_{GS} = 0\text{V}$		21	A
$I_{SM}$	Repetitive, Pulse Width Limited by $T_{JM}$		84	A
$V_{SD}$	$I_F = I_s$ , $V_{GS} = 0\text{V}$ , Note 1		1.5	V
$t_{rr}$			250	ns
$Q_{RM}$	$I_F = 21\text{A}$ , $-di/dt = 100\text{A}/\mu\text{s}$	1.2		$\mu\text{C}$
$I_{RM}$	$V_R = 100\text{V}$ , $V_{GS} = 0\text{V}$	10		A

Note: 1. Pulse test,  $t \leq 300 \mu\text{s}$ , duty cycle  $d \leq 2\%$

#### Min Recommended Footprint

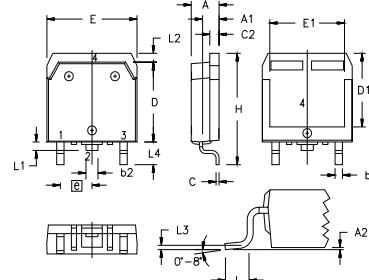


#### TO-247 (IXFH) Outline



Dim.	Millimeter Min.	Millimeter Max.	Inches Min.	Inches Max.
A	4.7	5.3	.185	.209
A <sub>1</sub>	2.2	2.54	.087	.102
A <sub>2</sub>	2.2	2.6	.059	.098
b	1.0	1.4	.040	.055
b <sub>1</sub>	1.65	2.13	.065	.084
b <sub>2</sub>	2.87	3.12	.113	.123
C	.4	.8	.016	.031
D	20.80	21.46	.819	.845
E	15.75	16.26	.610	.640
e	5.20	5.72	.205	.225
L	19.81	20.32	.780	.800
L <sub>1</sub>		4.50		.177
$\emptyset P$	3.55	3.65	.140	.144
Q	5.89	6.40	.232	.252
R	4.32	5.49	.170	.216
S	6.15	BSC	242	BSC

#### TO-268 Outline



SYM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	.193	.201	4.90	5.10
A <sub>1</sub>	.106	.114	2.70	2.90
A <sub>2</sub>	.001	.010	0.02	0.25
b	.045	.057	1.15	1.45
b <sub>2</sub>	.075	.083	1.90	2.10
C	.016	.026	0.40	0.65
C <sub>2</sub>	.057	.063	1.45	1.60
D	.543	.551	13.80	14.00
D <sub>1</sub>	.488	.500	12.40	12.70
E	.624	.632	15.85	16.05
E <sub>1</sub>	.524	.535	13.30	13.60
e	.215	BSC	5.45	BSC
H	.736	.752	18.70	19.10
L	.094	.106	2.40	2.70
L <sub>1</sub>	.047	.055	1.20	1.40
L <sub>2</sub>	.039	.045	1.00	1.15
L <sub>3</sub>	.010	BSC	0.25	BSC
L <sub>4</sub>	.150	.161	3.80	4.10

IXYS Reserves the Right to Change Limits, Test Conditions, and Dimensions.

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